

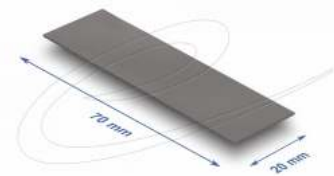
# Delock Thermal Conductive Pad 70 x 20 x 0.75 mm for M.2 modules 3.2 W/mK - Low Oil Bleeding

## Description

This thermal conductive pad by Delock is suitable for heat dissipation, for example, on an M.2 module. The goal of the pad is to **improve performance** and **increase the service life** of the components.

### Low oil bleeding

This pad **releases very little oil**, which protects electronic components and contacts from contamination and can provide a longer lifespan. Pads with 'low oil bleeding' retain their thermal and mechanical properties better and thus ensure even and stable heat dissipation.



height 0.75 mm

**Item no. 18403**

EAN: 4043619184033

Country of origin: Taiwan,  
Republic of China

Package: Zip poly bag

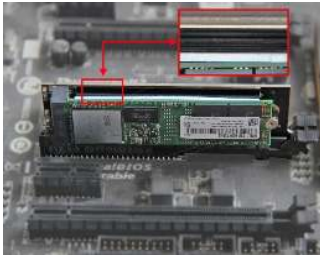
## Technical details

- Thermal pad for heat dissipation
- Low oil bleeding
- Thermal conductivity: 3.2 W/mK
- Operating temperature: -60 °C ~ 180 °C
- Colour: grey
- Dimensions (LxWxH): ca. 70 x 20 x 0.75 mm

## Package content

- 1 x thermal conductive pad

## Images



## Physical characteristics

|                 |                |
|-----------------|----------------|
| Material:       | silicone       |
| Length:         | 70 mm          |
| Width:          | 20 mm          |
| Height:         | 0.75 mm        |
| Colour:         | black<br>white |
| Cable diameter: | 5 mm           |

## Manufacturer information

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|             |                   |
|-------------|-------------------|
| Street      | Beeskowdamm 13/15 |
| Postal code | 14167             |
| City        | Berlin            |
| Country     | Deutschland       |
| E-Mail      | info@delock.de    |
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